

UNITED STATES PATENT AND TRADEMARK OFFICE

CV

UNITED STATES DEPARTMENT OF COMMERC United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450

| APPLICATION NO. | l l | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO | |
|------------------------|------|----------------|-------------------------|-----------------------|-----------------|--|
| 09/680,286 | | 10/06/2000 | Eric N. Paton | ENP-101 | 8985 | |
| 24117 | 7590 | 02/12/2004 | | EXAMINER | | |
| ERIC PAT | | Y-T | NOLAND, THOMAS | | | |
| 498 RIO GE Morgan I | | · - | | ART UNIT PAPER NUMBER | | |
| | | | | 2856 | | |
| | | | DATE MAILED: 02/12/2004 | | | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | Application No. | Applicant(s) | |
|--|---|---|--|
| Advisory Action | 09/680,286 | PATON, ERIC N. | |
| Advisory Action | Examiner | Art Unit | |
| | Thomas P. Noland | 2856 | |
| Th MAILING DATE of this communication appe | ars on the cover sheet with the c | correspondence address | |
| THE REPLY FILED FAILS TO PLACE THIS APPLICATION FAILS TO PLACE THIS APPLICATION THE REPLY FILED FAILS TO PLACE THIS APPLICATION FOR THE PLACE THIS APPLICATION FOR THE PLACE THE | void abandonment of this applic 1) a timely filed amendment whi al (with appeal fee); or (3) a time | cation. A proper reply to a ch places the application in | |
| | PLY [check either a) or b)] | • | |
| a) The period for reply expires 3 months from the mailing date of b) The period for reply expires on: (1) the mailing date of this Advevent, however, will the statutory period for reply expire later the ONLY CHECK THIS BOX WHEN THE FIRST REPLY WAS 706.07(f). Extensions of time may be obtained under 37 CFR 1.136(a). The danave been filed is the date for purposes of determining the period of extensions of the status of the shortened b) above, if checked. Any reply received by the Office later than three most armed patent term adjustment. See 37 CFR 1.704(b). | risory Action, or (2) the date set forth in the an SIX MONTHS from the mailing date of FILED WITHIN TWO MONTHS OF THE te on which the petition under 37 CFR 1.1 sion and the corresponding amount of the statutory period for reply originally set in | f the final rejection. E FINAL REJECTION. See MPEP 136(a) and the appropriate extension fee fee. The appropriate extension fee under the final Office action; or (2) as set forth in | |
| 1. A Notice of Appeal was filed on Appellant' 37 CFR 1.192(a), or any extension thereof (37 CF | R 1.191(d)), to avoid dismissal | | |
| 2. The proposed amendment(s) will not be entered b | ecause: | | |
| (a) they raise new issues that would require furth | | see NOTE below); | |
| (b) they raise the issue of new matter (see Note beginning) | · | | |
| (c) ☐ they are not deemed to place the application issues for appeal; and/or | in better form for appeal by mat | erially reducing or simplifying the | |
| (d) they present additional claims without cancel | ling a corresponding number of | finally rejected claims. | |
| NOTE: <u>See Continuation Sheet</u> . | | | |
| 3. Applicant's reply has overcome the following rejection. | · , | | |
| Newly proposed or amended claim(s) would canceling the non-allowable claim(s). | | · · | |
| 5. ☐ The a) ☐ affidavit, b) ☐ exhibit, or c) ☐ request fo application in condition for allowance because: Se | | sidered but does NOT place the | |
| 6. The affidavit or exhibit will NOT be considered be raised by the Examiner in the final rejection. | cause it is not directed SOLELY | to issues which were newly | |
| 7. For purposes of Appeal, the proposed amendment explanation of how the new or amended claims w | | | |
| The status of the claim(s) is (or will be) as follows: | | | |
| Claim(s) allowed: | | | |
| Claim(s) objected to: | | | |
| Claim(s) rejected: | | | |
| Claim(s) withdrawn from consideration: | | | |
| 8. The drawing correction filed on 17 November 2005 | $\underline{3}$ is a) $⊠$ approved or b) $□$ dis | approved by the Examiner. | |
| 9. Note the attached Information Disclosure Stateme | ent(s)(PTO-1449) Paper No(s). | · | |
| 10. Other: A proposed allowable claim is attached as requ | rested. | | |
| | | | |

Continuation of 2. NOTE: The change from "capital goods" to _- - - semiconductor substrate - - - in the claims and specification raises a new issue and the issue of new matter since the use of the invention to monitor a semiconductor substrate per se was not specifically heretofore claimed or disclosed even though it may have been generically disclosed.

Continuation of 5. does NOT place the application in condition for allowance because: directed to nonentered subject matter and for reasons equivalent to those given in the final rejection. Applicant's response does not eliminate the 35 U.S.C. 112(2) issue regarding critical parameters.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tom Noland whose telephone number is (571) 272-2202. The examiner can normally be reached on weekdays from 9:00 to 5:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mr. Hezron E. Williams, can be reached on (571) 272-2208.

The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Thomas P. Noland Primary Examiner Art Unit 2856

Continuation of 10. The application would be allowable over the prior art of record if the following amendment is made. (Note the claim and specification amendments filed Nov. 17, 2003 were not entered.) Please do not propose amending the specification and drawings unless obvious informalities are noted. A 3 month time extension fee will be required and the response must be filed by March 4, 2004 to avoid abandonment. It is sugested that the response include an authorization to correct obvious minor informalities by examiner's amendment.

Proposed response:

Cancel claims 18-33.

Add new claim 34 as follows:

Claims 1-33 (cancelled)

Claim 16 (currently amended)—An apparatus for measuring critical parameters used in an integrated circular of medical parameters used in manufacturing of eapital goods <u>semiconductor substrate</u> in microelectronic processing without evasive interruptions to manufacturing equipment, the oritical parameters selected from the group consisting of temperature, liquid and gas flow rate, distance, particles, humidity, pressure, viscosity, radiation, velocity, density, acceleration, stress/strain, pH, the critical parameters related to chemical/material analysis techniques

de termined using techniques

selected from the group consisting of Energy Dispersive x-ray Spectroscopy (EDS), Cathodoluminescence (CL), X-ray Photoelectron Spectroscopy (XPS), Ultraviolet Photoelectron Spectroscopy (UPS), Auger, Electron Spectroscopy (AES), Reflection High Energy Electron Diffraction (REELS), X-ray Fluorescence (XRF), Photoluminescence (PL), Modulation Spectroscopy, Variable Angle Spectroscopic Ellipsometry (VASE), Fourier Transform Infrared Spectroscopy (FTIR), Raman Spectroscopy, Solid State Nuclear Magnetic Resonance (NMR), Rutherford Backscattering Spectroscopy (RBS), Elastic Recoil Spectroscopy (ERS), Ion Scattering Spectroscopy (ISS), Residual Gas Analyzer (RGA), Dynamic/Static Secondary Ion Mass Spectroscopy, Laser Ionization Mass Spectroscopy (LIMS), Sputtered Neutral Mass Spectroscopy (SNMS), Glow Discharge Mass Spectroscopy (GDMS), Inductively Coupled Plasma Mass Spectroscopy, Inductively Coupled Plasma Optical Emission Spectroscopy, Neutron Diffraction, Neutron Reflectivity, Neutron Activation Analysis (NAA), Nuclear Reaction Analysis (NRA) and combinations thereof, the apparatus a sulface comprising:

one or more sensors, the one or more sensors attached to surfaces on the enpital integrated circuit or micronachanical device goods semiconductor substrate for collecting data therefrom;

an electronic device for processing data collected from the one or more sensors;

and an energy source for the electronic device, wherein said sensors and electronic device

integrated a reside completely on the surface of the eapital goods semiconductor substrate.

wherein the energy source is a battery functional at femperatures up to 150°C; wherein the electronic device comprise, an analog to wherein the electronic device comprise, an analog to digital converter, a signal conditioning device, and and is solid state memory device for collecting data; the apparatus further comprising an entire

external wireless receiving module wherein the collected data is transmitted digitally in real-time from the electronic device to the external wireless receiving module,*

the apparetus further comprising an

isolation material to protect the electronic device from hostile manufacturing or

processing environments.

and wherein The one or more

Sensors, the electronic device components

and the battery are radiation hard.

2/8/07 THOMAS P. NOLAND PRIMARY EXAMINER

Thom NV